

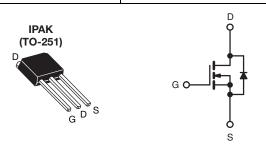
RoHS

HALOGEN

FREE

Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|------------------------|--------|--|--|--|
| V _{DS} (V) | 10 | 100 | | | |
| $R_{DS(on)}(\Omega)$ | V _{GS} = 10 V | 0.54 | | | |
| Q _g (Max.) (nC) | 8.3 | 3 | | | |
| Q _{gs} (nC) | 2.3 | 3 | | | |
| Q _{gd} (nC) | 3.8 | 3 | | | |
| Configuration | Sing | Single | | | |



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Straight Lead
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

| ORDERING INFORMATION | | | | |
|---------------------------------|---------------|--|--|--|
| Package | IPAK (TO-251) | | | |
| Lead (Pb)-free and Halogen-free | SiHFU110-GE3 | | | |
| Lead (Pb)-free | IRFU110PbF | | | |
| Lead (i b) nee | SiHFU110-E3 | | | |
| SnPb | IRFU110 | | | |
| Oil D | SiHFU110 | | | |

| ABSOLUTE MAXIMUM RATINGS (T_C | = 25 °C, unl | ess otherwis | se noted) | | | |
|--|-------------------------|---|-----------------------------------|------------------|------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 100 | V | |
| Gate-Source Voltage | | | V_{GS} | ± 20 | | |
| Continuous Drain Current | \/ -+ 10\/ | $T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$ | - I _D | 4.3 | А | |
| | V _{GS} at 10 V | T _C = 100 °C | | 2.7 | | |
| Pulsed Drain Current ^a | | | I _{DM} | 17 | | |
| Linear Derating Factor | | | | 0.2 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 75 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 4.3 | А | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 2.5 | mJ | |
| Maximum Power Dissipation | T _C = 25 °C | | P _D | 25 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 5.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 150 | 00 | |
| Soldering Recommendations (Peak Temperature) | for 10 s | | _ | 300 ^d | °C | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 8.1 mH, R_g = 25 Ω , I_{AS} = 4.3 A (see fig. 12).
- c. $I_{SD} \le 5.6$ A, $dI/dt \le 75$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|-------------------|------|------|------|------|--|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | - | 110 | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | - | 5.0 | C/VV | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | | |
|---|-----------------------|---|---|------|--|-------|------|--|
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 100 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference to 25 °C, I _D = 1 mA | | - | 0.63 | - | V/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | | 2.0 | - | 4.0 | V | |
| Gate-Source Leakage | I _{GSS} | V _{GS} = ± 20 V | | - | - | ± 100 | nA | |
| Zana Onto Walliano Burino Carante | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V | | - | - | 25 | | |
| Zero Gate Voltage Drain Current | | V _{DS} = 80 V | V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | μA | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 0.90 A ^b | - | - | 0.54 | Ω | |
| Forward Transconductance | 9fs | V _{DS} = | 50 V, I _D = 0.90 A | 1.1 | - | - | S | |
| Dynamic | | | | | | | | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$ | | - | 180 | - | pF | |
| Output Capacitance | C _{oss} | | | - | 81 | - | | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 15 | - | | |
| Total Gate Charge | Qg | | I _D = 5.6 A, V _{DS} = 80 V, see fig. 6 and 13 ^b | - | - | 8.3 | nC | |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | | - | - | 2.3 | | |
| Gate-Drain Charge | Q _{gd} | 1 | | - | - | 3.8 | | |
| Turn-On Delay Time | t _{d(on)} | | | - | 6.9 | - | | |
| Rise Time | t _r | $V_{DD} = 50 \text{ V}, I_D = 5.6 \text{ A},$ $R_g = 24 \Omega, R_D = 8.4 \Omega, \text{ see fig. } 10^b$ | | - | 16 | - | - ns | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 15 | - | | |
| Fall Time | t _f | | | - | 9.4 | - | | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.0 | - | ml l | |
| Internal Source Inductance | L _S | | | - | 6.0 | - | - nH | |
| Drain-Source Body Diode Characteristic | s | | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | ı | 1.5 | - A | |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 12 | | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I _S = 1.5 A, V _{GS} = 0 V ^b | | - | - | 2.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 5.6 A, dl/dt = 100 A/μs ^b | | - | 100 | 200 | ns | |
| Body Diode Reverse Recovery Charge | Q_{rr} | | | - | 0.44 | 0.88 | μC | |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on i | | | on is dominated by L _S and L _D) | | | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s$; duty cycle $\leq 2~\%$.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

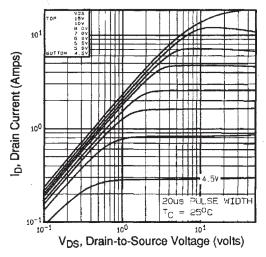


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

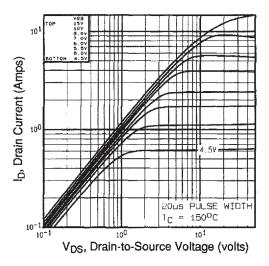


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

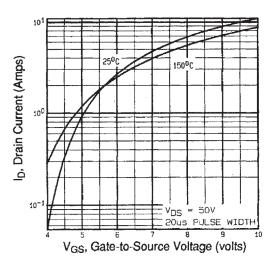


Fig. 3 - Typical Transfer Characteristics

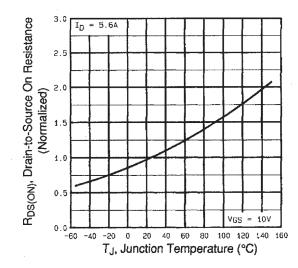


Fig. 4 - Normalized On-Resistance vs. Temperature



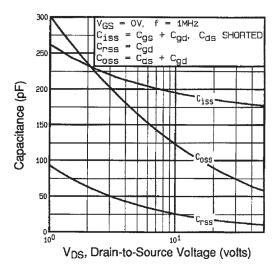


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

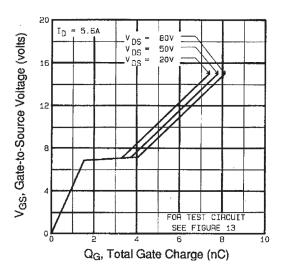


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

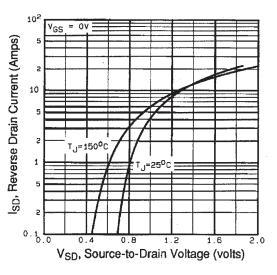


Fig. 7 - Typical Source-Drain Diode Forward Voltage

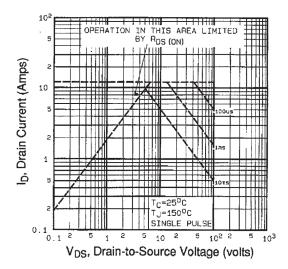


Fig. 8 - Maximum Safe Operating Area



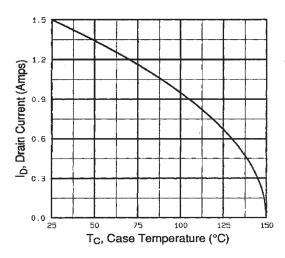


Fig. 9 - Maximum Drain Current vs. Case Temperature

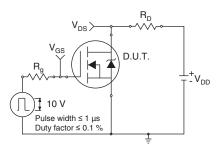


Fig. 10a - Switching Time Test Circuit

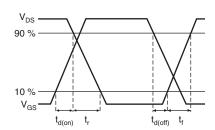


Fig. 10b - Switching Time Waveforms

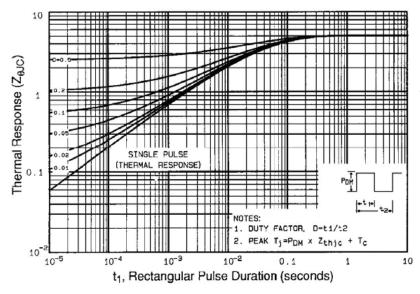


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



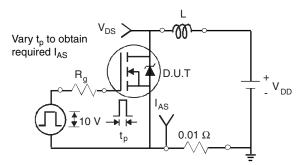


Fig. 12a - Unclamped Inductive Test Circuit

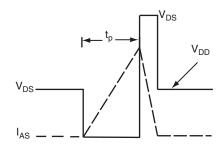


Fig. 12b - Unclamped Inductive Waveforms

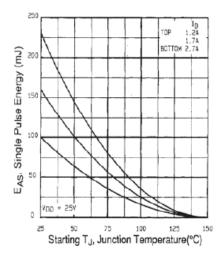


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

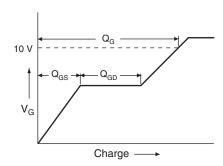


Fig. 13a - Basic Gate Charge Waveform

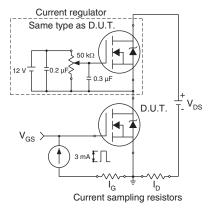
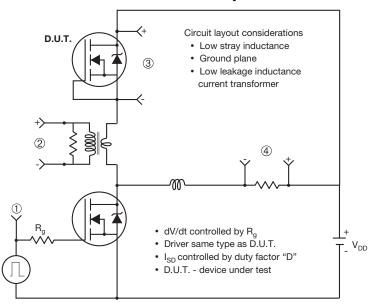


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



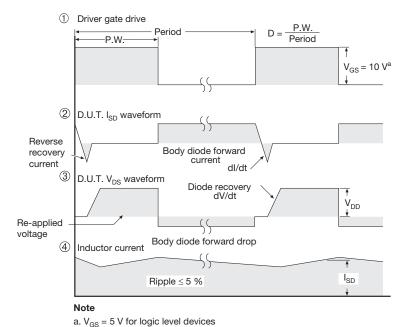


Fig.14 - For N-Channel

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